



- NOTES:
1. MATERIAL SPECIFICATION
 - 1) INSULATION MATERIAL: THERMOPLASTIC.
 - 2) SHELL: COPPER ALLOY/SPCC, T: 0.30mm
 - PLATING: NICKEL
 - 3) TERMINAL: COPPER ALLOY, T: 0.25mm
- PLATING: GOLD/TIN PLATED.
2. ELECTRICAL CHARACTERISTIC:
 - 1) INSULATION RESISTANCE: 1000MΩ MIN.
 - 2) CONTACT RESISTANCE: 30mΩ MAX.
 - 3) WITHSTANDING VOLTAGE: 500V AC.
3. MECHANICAL CHARACTERISTICS:
 - 1) INSERTION FORCE: 3.57kgf MAX.
 - 2) EXTRACTION FORCE: 1.02kgf MIN.

		MATERIAL	UNIT	CHECKED BY	DESIGNED BY	DATE	PRODUCT NAME
X	±0.1		mm			07/03/12	US05-X-04-S1
X.X	±0.05			APPROVAL BY	DRAWING		USB A UPRIGHT
X.XX	±0.005						
X.XXX	±0.002						SHINHW A TECH CO., LTD

1 2 3 4 5 6 7 8 9

A B C D E

1 2 3 4 5 6